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Contents

- xi Conference Committee
- xv Introduction

SESSION 1 ADVANCED LITHOGRAPHY

- 7521 02 Immersion lithography and double patterning in advanced microelectronics [7521-45]
 T. Vandeweyer, J. Bekaert, M. Ercken, R. Gronheid, A. Miller, V. Truffert, S. Verhaegen, J. Versluijs, V. Wiaux, P. Wong, G. Vandenberghe, M. Maenhoudt, IMEC (Belgium)
- 7521 03 **Projection photolithography modeling using the finite-difference time-domain approach** [7521-10]

T. M. Makhviladze, M. E. Sarychev, Institute of Physics and Technology (Russian Federation)

- Manufacturing of diffraction-quality optical elements for high-resolution optical systems [7521-38]
 N. I. Chkhalo, A. E. Pestov, N. N. Salashchenko, M. N. Toropov, Institute for Physics of Microstructures (Russian Federation)
- Influence of annealing on the structural and optical properties of thin multilayer EUV filters containing Zr, Mo, and silicides of these metals [7521-50]
 N. I. Chkhalo, S. A. Gusev, M. N. Drozdov, E. B. Kluenkov, A. Ya. Lopatin, V. I. Luchin, A. E. Pestov, N. N. Salashchenko, Institute for Physics of Microstructures (Russian Federation);
 L. A. Shmaenok, PhysTeX (Netherlands); N. N. Tsybin, Institute for Physics of Microstructures (Russian Federation)

SESSION 2 PLASMA PHYSICS AND PROCESSING

- 7521 06 **The metal hard-mask approach for contact patterning** [7521-46] J.-F. de Marneffe, F. Lazzarino, D. Goossens, Th. Conard, I. Hoflijk, D. Shamiryan, H. Struyf, W. Boullart, IMEC (Belgium)
- 7521 07 Impact of plasma exposure on organic low-k materials [7521-53]
 E. Smirnov, IMEC (Belgium) and Moscow Institute of Electronic Technology (Russian Federation); A. K. Ferchichi, C. Huffman, M. R. Baklanov, IMEC (Belgium)
- 7521 08 Plasma parameters and active particles kinetics in HBr dc glow discharges [7521-06] A. Smirnov, Ivanovo State Univ. of Chemistry and Technology (Russian Federation) and Mikron JSC (Russian Federation); A. Efremov, V. Svettsov, Ivanovo State Univ. of Chemistry and Technology (Russian Federation); A. Islyaykin, Mikron JSC (Russian Federation)
- 7521 09 Excitation mechanism of the B⁺ emission line at 345.1 nm in low-temperature plasmas [7521-02]

V. P. Kudrya, Institute of Physics and Technology (Russian Federation)

- 7521 0A Application of Langmuir probe technique in depositing plasmas for monitoring of etch process robustness and for end-point detection [7521-28] A. V. Miakonkikh, K. V. Rudenko, Institute of Physics and Technology (Russian Federation)
- 7521 OB Optimization of parameters of process deep plasmachemical etching of silicon for elements MEMS [7521-27]
 A. I. Vinogradov, N. M. Zarjankin, J. A. Mihajlov, E. P. Prokopev, S. P. Timoshenkov, Moscow State Institute of Electronic Technologies (Russian Federation)

SESSION 3 STRUCTURES FOR PHOTONICS AND OPTOELECTRONICS

- 7521 0C Defect-related luminescence from nanostructured Si layers in the 1.5-1.6 μm wavelength region [7521-19]
 A. A. Shklyaev, A. B. Latyshev, Institute of Semiconductor Physics (Russian Federation) and Novosibirsk State Univ. (Russian Federation); M. Ichikawa, The Univ. of Tokyo (Japan)
- 7521 0D Improvement of radiation resistance of multijunction solar cells by application of Bragg reflectors [7521-25]
 V. Emelyanov, N. Kaluzhniy, S. Mintairov, M. Shvarts, V. Lantratov, Ioffe Physico-Technical Institute (Russian Federation)
- 7521 OE Laser generation in broken-gap heterostructures [7521-30] I. Semenikhin, Institute of Physics and Technology (Russian Federation); K. A. Chao, Lund Univ. (Sweden) and Linköping Univ. (Sweden); A. Zakharova, Institute of Physics and Technology (Russian Federation)
- 7521 OF Noise suppression in three-level atomic system driven by quantized field [7521-33] A. Gelman, V. Mironov, Institute of Applied Physics (Russian Federation)
- 7521 0G Numerical methods for calculation of optical properties of layered structures [7521-56]
 S. A. Dyakov, Trinity College Dublin (Ireland) and Moscow Univ. (Russian Federation);
 V. A. Tolmachev, E. V. Astrova, loffe Physico-Technical Institute (Russian Federation);
 S. G. Tikhodeev, General Physics Institute (Russian Federation); V. Yu. Timoshenko, Moscow Univ. (Russian Federation); T. S. Perova, Trinity College Dublin (Ireland)

SESSION 4 THIN FILMS

- 7521 OH The thickness-dependence of the polariton effect in the single quantum well [7521-14] Yu. V. Moskalev, Yaroslavl State Pedagogical Univ. (Russian Federation); S. B. Moskovskii, Yaroslavl State Univ. (Russian Federation)
- 7521 01 Low-resistance Ge/Au/Ni/Ti/Au-based ohmic contact to n-GaAs [7521-16] V. Kagadei, Research and Production Company Micran (Russian Federation); E. Erofeev, Scientific Research Institute of Electrical Communication Systems (Russian Federation)

7521 0J Hf-based barrier layers for Cu-metallization [7521-39]

I. A. Khorin, Institute of Physics and Technology (Russian Federation) and Moscow State Institute of Radio-engineering, Electronics and Automation (Russian Federation); Yu. I. Denisenko, V. N. Gusev, Yaroslavl Branch of Institute of Physics and Technology (Russian Federation); A. A. Orlikovsky, A. E. Rogozhin, Institute of Physics and Technology (Russian Federation); V. I. Rudakov, Yaroslavl Branch of Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation)

7521 0K Formation of Ge/Cu ohmic contacts to n-GaAs with atomic hydrogen pre-annealing step [7521-17]

E. Erofeev, Scientific Research Institute of Electrical Communication Systems (Russian Federation); V. Kagadei, Research and Production Company Micran (Russian Federation)

7521 OL CoSi₂/TiO₂/SiO₂/Si gate structure formation [7521-37]

A. E. Rogozhin, Institute of Physics and Technology (Russian Federation); I. A. Khorin, Institute of Physics and Technology (Russian Federation) and Moscow Institute of Radio-engineering, Electronics and Automation (Russian Federation); V. V. Naumov, Yaroslavl Branch of Institute of Physics and Technology (Russian Federation); A. A. Orlikovsky, Institute of Physics and Technology (Russian Federation); V. V. Nudakov, Yaroslavl Branch of Institute of Physics and Technology (Russian Federation); A. A. Orlikovsky, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation); A. G. Vasiliev, Institute of Physics and Technology (Russian Federation) and Federal State Unitary Enterprise Pulsar (Russian Federation)

SESSION 5 SUPERCONDUCTING AND MAGNETIC STRUCTURES

7521 0M Theoretical analysis of the new microwave detector based on a Josephson heterostructure [7521-40]

I. A. Devyatov, M. Yu. Kupriyanov, Lomonosov Moscow State Univ. (Russian Federation)

7521 0N Theoretical analysis of electronic thermal properties of the interfaces between multiband superconductors and a normal metal [7521-42]
 I. A. Devyatov, M. Yu. Romashka, Lomonosov Moscow State Univ. (Russian Federation);
 A. V. Semenov, Moscow State Pedagogical Univ. (Russian Federation); P. A. Krutitskii,
 Keldysh Institute for Applied Mathematics (Russian Federation); M. Yu. Kuprivanov,

Keldysh Institute for Applied Mathematics (Russian Federation); M. Yu. Kupriyanov, Lomonosov Moscow State Univ. (Russian Federation)

- 7521 00 Superconductivity of polymers with charge injection doping [7521-44] A. N. Ionov, loffe Physico-Technical Institute (Russian Federation); R. R. Rentzsch, Freie Univ. Berlin (Germany)
- 7521 OP High-temperature magnetization and Mössbauer spectra of nanoparticles in a weak magnetic field [7521-36] M. A. Chuey, Institute of Physics and Technology (Russian Federation)

M. A. Chuev, Institute of Physics and Technology (Russian Federation)

7521 0Q Mossbauer study of nanomagnetics [7521-52]

V. I. Bachurin, I. N. Zakharova, Yaroslavl State Technical Univ. (Russian Federation); M. A. Shipilin, Yaroslavl State Univ. (Russian Federation); A. M. Shipilin, Lomonosov Moscow State Univ. (Russian Federation)

7521 OR A new antiferromagnetic nanocomposite GdNiO₃ [7521-43] A. I. Rykova, V. M. Dmitriev, E. N. Khatsko, A. V. Terekhov, A. S. Cherny, D. S. Kondrashev, B.I. Verkin Institute for Low Temperature Physics and Engineering (Ukraine); T. Mydlarz, A. Zaleski, International Lab. of High Magnetic Fields and Low Temperatures (Poland); A. D. Shevshenko, V. M. Uvarov, G.V. Kurdyumov Institute for Metal Physics (Ukraine)

SESSION 6 PHYSICS OF NANOSTRUCTURES

- 7521 0S Calculation of electrophysical parameters of thin undoped GaAs-in-Al₂O₃ quantum nanowires and single-wall armchair carbon nanotubes [7521-18] D. Pozdnyakov, A. Borzdov, V. Borzdov, Belarusian State Univ. (Belarus); V. Labunov, Belarusian State Univ. of Informatics and Radioelectronics (Belarus)
- 7521 0T Penetration of quantum-mechanical current density under semi-infinite rectangular potential barrier as the consequence of the interference of the electron waves in semiconductor 2D nanostructures [7521-29]
 - V. A. Petrov, A. V. Nikitin, Institute of Radioengineering and Electronics (Russian Federation)
- 7521 0U Calculation of the characteristics of electron transport through molecular clusters [7521-32]
 Y. S. Gerasimov, Russian Research Ctr. Kurchatov Institute (Russian Federation);
 V. V. Shorokhov, E. S. Soldatov, Lomonosov Moscow State Univ. (Russian Federation);
 O. V. Snigirev, Russian Research Ctr. Kurchatov Institute (Russian Federation) and Lomonosov Moscow State Univ. (Russian Federation)
- 7521 0V Determination of electronic properties of molecular objects on the basis of nanodevices' transport characteristics [7521-48]
 V. A. Malinin, V. V. Shorokhov, E. S. Soldatov, Lomonosov Moscow State Univ. (Russian Federation)
- 7521 0W **Electron optical spin polarization in broken-gap heterostructures** [7521-24] A. Zakharova, Institute of Physics and Technology (Russian Federation); K. A. Chao, Lund Univ. (Sweden) and Linköping Univ. (Sweden); I. Semenikhin, Institute of Physics and Technology (Russian Federation)

SESSION 7 NANOSTRUCTURES FABRICATION TECHNIQUES

- 7521 0X Femtosecond and nanosecond laser assistant formation of Si nanoclusters in silicon-rich nitride films [7521-07]
 V. A. Volodin, Institute of Semiconductor Physics (Russian Federation) and Novosibirsk State Univ. (Russian Federation); T. T. Korchagina, G. N. Kamaev, A. Kh. Antonenko, Institute of Semiconductor Physics (Russian Federation); J. Koch, B. N. Chichkov, Laser Zentrum Hannover e.V. (Germany)
- 7521 0Y Formation of carbonic nanostructures using PECVD and glow-discharge plasma at direct current [7521-51]
 D. G. Gromov, S. A. Gavrilov, S. V. Dubkov, Moscow Institute of Electronic Technology (Russian Federation)

- 7521 0Z Carbon nanostructures' catalytic growth from carbonaceous substrates in comparison with PECCVD method [7521-55]
 Ye. Yu. Alekseeva, E. A. Il'ichev, V. N. Inkin, D. M. Migunov, G. N. Petruhin, E. A. Poltoratskii, G. S. Rychkov, D. V. Shkodin, Federal State Research Institute of Physical Problems named
- 7521 10 **Preparation of electrodes for molecular transistor by focused ion beam** [7521-31] I. V. Sapkov, Lomonosov Moscow State Univ. (Russian Federation); V. V. Kolesov, Kotel'nikov Institute of Radioengineering and Electronics (Russian Federation); E. S. Soldatov, Lomonosov Moscow State Univ. (Russian Federation)
- Si wires growth by using of magnetron sputtering method [7521-34]
 S. A. Evlashin, V. A. Krivchenko, P. V. Pastchenko, A. T. Rakhimov, N. V. Suetin, M. A. Timofevev, Lomonosov Moscow State Univ. (Russian Federation)
- 7521 12 **Formation of molecular transistor electrodes by electromigration** [7521-47] A. S. Stepanov, Russian Research Ctr. Kurchatov Institute (Russian Federation); E. S. Soldatov, Lomonosov Moscow State Univ. (Russian Federation); O. V. Snigirev, Russian Research Ctr. Kurchatov Institute (Russian Federation) and Lomonosov Moscow State Univ. (Russian Federation)
- Formation of the atomically smooth surface of gold film and binding of gold nano-particles on it by self-assembly method [7521-54]
 A. N. Kuturov, P.N. Lebedev Physical Institute (Russian Federation); E. S. Soldatov, Lomonosov Moscow State Univ. (Russian Federation); L. A. Polyakova, S. P. Gubin, Institute of General Inorganic Chemistry (Russian Federation)

SESSION 8 MICRO- AND NANOSTRUCTURES CHARACTERIZATION

after F.V. Lukin (Russian Federation)

7521 14 Investigations of nanostructured porous PbTe films with x-ray diffractometry and reflectometry [7521-22]

S. P. Zimin, V. M. Vasin, Yaroslavl State Univ. (Russian Federation); E. S. Gorlachev, Yaroslavl Branch of the Institute of Physics and Technology (Russian Federation); A. P. Petrakov, S. V. Shilov, Syktyvkar State Univ. (Russian Federation)

7521 15 Experimental scheme for observation of anomalous Kossel effect in semiconductor crystals [7521-35]

P. G. Medvedev, M. A. Chuev, Institute of Physics and Technology (Russian Federation); M. V. Kovalchuk, E. M. Pashaev, I. A. Subbotin, S. N. Yakunin, Russian Research Ctr. Kurchatov Institute (Russian Federation)

7521 16 SEM probe defocusing method of measurement of linear sizes of nanorelief elements [7521-49]

M. N. Filippov, N.S. Kurnakov Institute of General and Inorganic Chemistry (Russian Federation); Yu. A. Novikov, A.M. Prokhorov General Physics Institute (Russian Federation); A. V. Rakov, P. A. Todua, Ctr. for Surface and Vacuum Research (Russian Federation)

SESSION 9 DEVICES AND ICS

- 7521 17 **Electromigration theory and its applications to integrated circuit metallization** [7521-08] T. M. Makhviladze, M. E. Sarychev, Institute of Physics and Technology (Russian Federation)
- 7521 18 **Methods of cache memory optimization for multimedia applications** [7521-20] A. Kravtsov, JSC Mikron (Russian Federation)
- Principal problems of quality improvement for high-speed planar transmission lines issued from studies of high-Q microstrip resonators [7521-41]
 A. P. Chernyaev, Lomonosov Moscow State Univ. (Russian Federation); V. A. Dravin, P.N. Lebedev Physical Institute (Russian Federation); A. Y. Golovanov, P.N. Lebedev Physical Institute (Russian Federation); A. Y. Golovanov, P.N. Lebedev Physical Institute (Russian Federation); A. Y. Golovanov, P.N. Lebedev Physical Institute (Russian Federation) and Lomonosov Moscow State Univ. (Russian Federation); A. L. Karuzskii, A. E. Krapivka, A. N. Lykov, V. N. Murzin, A. V. Perestoronin, A. M. Tskhovrebov, N. A. Volchkov, P.N. Lebedev Physical Institute (Russian Federation)

SESSION 10 SIMULATION AND MODELING

7521 1A Advanced atomic-scale simulation of silicon nitride CVD from dichlorosilane and ammonia [7521-09]

T. M. Makhviladze, A. Kh. Minushev, Institute of Physics and Technology (Russian Federation)

7521 1B Thermodynamic theory of interfacial adhesion between materials containing point defects [7521-11]

R. V. Goldstein, Institute for Problems in Mechanics (Russian Federation); T. M. Makhviladze, M. E. Sarychev, Institute of Physics and Technology (Russian Federation)

- 7521 1C Modeling of the interfacial separation work in relation to impurity concentration in adjoining materials [7521-12]
 I. M. Alekseev, T. M. Makhviladze, A. Kh. Minushev, M. E. Sarychev, Institute of Physics and Technology (Russian Federation)
- 7521 1D Optimization of near-surficial annealing for decreasing of depth of p-n-junction in semiconductor heterostructure [7521-01]
 E. L. Pankratov, Nizhny Novgorod State Univ. of Architecture and Civil Engineering (Russian Federation)
- 7521 1E A nanoelectronic device simulation software system NANODEV: new opportunities [7521-13]
 I. I. Abramov, A. L. Baranoff, I. A. Goncharenko, N. V. Kolomejtseva, Y. L. Bely,
 I. Y. Shcherbakova, Belarusian State Univ. of Informatics and Radioelectronics (Belarus)
- 7521 1F Radiation-hardening-by-design with circuit-level modeling of total ionizing dose effects in modern CMOS technologies [7521-15]
 M. S. Gorbunov, Scientific-Research Institute of System Analysis (Russian Federation);
 G. I. Zebrev, National Research Nuclear Univ. (Russian Federation); P. N. Osipenko, Scientific-Research Institute of System Analysis (Russian Federation)
- 7521 1G Simulation results for three neutralization channel designs of a fast neutral beam source [7521-26]

A. V. Degtyarev, V. P. Kudrya, Yu. P. Maishev, Institute of Physics and Technology (Russian Federation)

7521 1H Intrinsic compact MOSFET model with correct account of positive differential conductance after saturation [7521-23]

V. O. Turin, A. V. Sedov, Orel State Technical Univ. (Russian Federation); G. I. Zebrev, National Research Nuclear Univ. (Russian Federation); B. Iñiguez, Rovira i Virgili Univ. (Spain); M. S. Shur, Rensselaer Polytechnic Institute (United States)

Author Index

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Introduction

This volume contains selected papers from those presented at the International Conference on Micro- and Nanoelectronics 2009 (ICMNE-2009) which was held in Zvenigirod, Russia, October 5-9, 2009. The conference is a biannual event and continues the series of conferences focusing on current physical and technological problems in microelectronics and promising nanosized devices. Since 1992, the Institute of Physics and Technology of the Russian Academy of Sciences (FTIAN) has been the permanent organizer of the ICMNE conferences, and since 2003, the ICMNE has been an SPIE-affiliated conference.

The goals of the 2009 conference were to look forward to new concepts and technologies of integrated devices, and to join efforts of scientists in answer to the challenges of industry scaling down ICs to nanometer design rules. ICMNE 2009 featured a wide scope of presented papers in the urgent fields of the physics of micro- and nanostructures, techniques for its characterization, and bottleneck points in the technologies of micro- and nanoscale devices. The Conference focused on topical problems that were highlighted in the following sessions:

- Advanced Lithography
- Plasma Physics and Processing
- Structures for Photonics and Optoelectronics
- Thin Films
- Superconducting and Magnetic Structures
- Physics of Nanostructures
- Nanostructures Fabrication Techniques
- Micro- and Nanostructures Characterization
- Devices and ICs
- Simulation and Modeling

The scientific program comprised of a collection of invited and contributed papers from scientists employed at European and Siberian Regions of Russia, Eastern and Western Europe, and Asia. The invited lectures on current achievements and challenges in microelectronic and superconducting devices were delivered by scientists from USA, France, Belgium, Germany, Sweden, Japan, and Russia. The contributed presentations were made by speakers from academic institutions, universities, and industry. More than 80 contributions were discussed at oral sessions; the others were presented as posters.

Most of the papers at ICMNE are the results of latest investigations. We hope that helpful discussion of these works at the sessions of the conference and during personal contacts between attendees will promote the research activity in the microelectronics community. Additional information about ICMNE can be found at the conference website <u>http://www.icmne.ftian.ru/</u>

Konstantin Rudenko Dr. of Sci., Scientific Secretary of ICMNE 2009